

APPROVAL SHEET

WW08K, WW12K, WW25K

±1%, ±5%

Metal Ultra low ohm power chip resistors Size 0805 1/2W, 1206 1W, 2512 2W Metal Current Sensing Type RoHS Compliant and Halogen free Low EMF



FEATURE

- 1. Ultra low and stable TCR performance
- 2. High power rating and low EMF <+/-3uV/degreeC
- 3. High reliability and stability
- 4. Reduced size of final equipment
- 5. RoHS compliant and Lead free product
- Inductance below 1nH

APPLICATION

- Power supply
- PDA
- Digital meter
- Computer
- Automotives
- Battery charger
- DC-DC power converter

DESCRIPTION

The resistors are constructed in a high grade low resistive metal body. The resistive layer is covered with a protective coat and printed a resistance marking code over it. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a lead-free soder.

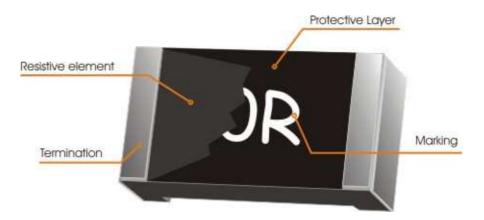


Fig 1. Construction of Chip-R



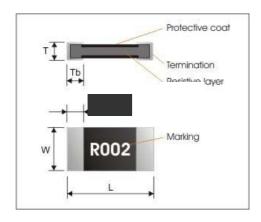
QUICK REFERENCE DATA

Item	General Specification			
Series No.	WW08K	WW12K	WW25K	
Size code	0805 (2012)	1206 (3216)	2512 (6432)	
Resistance Tolerance	±5%; ±1%	±5%; ±1%	±5%; ±1%	
Resistance Value	$0.005\Omega,0.006\Omega,$	$0.003\Omega,0.004\Omega,$	$0.003\Omega,0.004\Omega,0.005\Omega,0.010\Omega,0.015\Omega,0.020\Omega,$	
TCR (ppm/°C)	±100	±70	$0.003\Omega, 0.004\Omega, \pm 100$ $0.005\Omega \sim 0.020\Omega, \pm 70$	
Max. dissipation at T _{amb} =70°C	1/2 W	1 W	2 W	
Operation temperature	-55/+170'C	-55/+170°C	-55/+170°C	

Note:

- 1. This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8"
- 2. Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by $RCWV = \sqrt{RatedPower \times Resistance \, Value} \quad \text{or Max. RCWV listed above, whichever is lower.}$

MECHANICAL DATA



Symbol	WW08K	WW12K	WW25K	
L	2.00±0.15	3.10±0.20	6.20±0.20	
W	1.20±0.15	1.65±0.20	3.25±0.20	
Т	0.45±0.15	0.60±0.20	0.65±0.20	
Tt	0.33±0.20	0.60±0.20	0.80±0.20	
Tb	0.33±0.20	0.60±0.20	0.80±0.20	



MARKING

2512/1206

TOP: Marking. (4 Digits marking to identify the resistance value.)

 $R003=3m\Omega$



 $R005=5m\Omega \rightarrow R020=20m\Omega$

1206*: R003/R004/R006

TOP: Laser marking product.

Bottom: Index sign.

0805

TOP: No marking product.



R003

Bottom: Index sign.

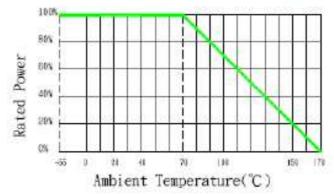


FUNCTIONAL DESCRIPTION

Derating curve

The power that the resistor can dissipate depends on the operating temperature; see Fig.2





MOUNTING

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems.

Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.



SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 3 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 3.

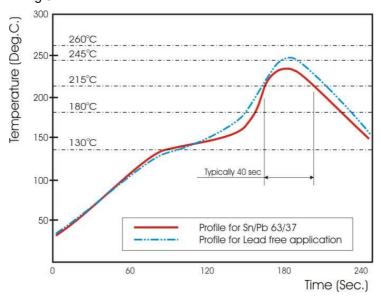


Fig 3. Infrared soldering profile for Chip Resistors WW25

CATALOGUE NUMBERS

The resistors have a catalogue number starting with .

WW08	K	R010	F	Т	L	
Size code	Type code	Resistance code	Tolerance	Packaging code	Termination code	
WW08:0805	K:	R is first digit followed by 3	J : ±5%	T:7" reeled in tape	L = Sn base	
WW12 : 1206	0805 - 1/2W	significant digits. F 0.010Ω = R010	3	F:±1%		(lead free)
WW25 : 2512	1206 - 1W					
	2512 – 2W					
	Metal strip Low EMF					

WW08K: 5,000 pcs per Paper Tape reel. WW12K: 4,000 pcs per PC Tape reel WW25K: 4,000 pcs per PC Tape reel



TEST AND REQUIREMENTS (JIS C 5201-1: 1998)

Essentially all tests are carried out according to the schedule of IEC publication 115-8, category LCT/UCT/56(rated temperature range: Lower Category Temperature, Upper Category Temperature; damp heat, long term, 56 days). The testing also meets the requirements specified by EIA, EIAJ and JIS.

The tests are carried out in accordance with IEC publication 68, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions according to IEC 60068-1, subclause 5.3. Unless otherwise specified, the following value supplied:

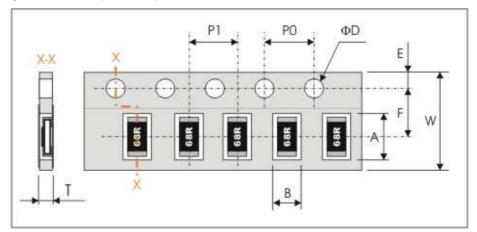
Temperature: 15°C to 35°C. Relative humidity: 45% to 75%.

Air pressure: 86kPa to 106 kPa (860 mbar to 1060 mbar). All soldering tests are performed with midly activated flux.

TEST	PROCEDURE	REQUIREMENT
Temperature Coefficient of Resistance(T.C.R) Clause 4.8	Natural resistance change per change in degree centigrade. $\frac{R_2-R_1}{R_1(t_2-t_1)}\times 10^6 \ \text{(ppm/°C)} t_1:20\text{°C}+5\text{°C}-1\text{°C}$ $\text{R}_1: \text{Resistance at reference temperature}$ $\text{R}_2: \text{Resistance at test temperature}$	Refer to "QUICK REFERENCE DATA"
Short time overload (S.T.O.L) Clause 4.13	Permanent resistance change after a 5 second application of 5 times rated power specified in the above list,	no visible damage J: Δ R/R max. \pm (2%+0.5m Ω) F: Δ R/R max. \pm (1%+0.5m Ω)
Resistance to soldering heat (R.S.H) Clause 4.18	Un-mounted chips completely immersed for 10±1second in a SAC solder bath at 270 $^{\circ}\text{C}\pm5^{\circ}\text{C}$	no visible damage J: Δ R/R max. \pm (1%+0.5m Ω) F: Δ R/R max. \pm (0.5%+0.5m Ω)
Solderability Clause 4.17	Un-mounted chips completely immersed for 3±0.5 second in a SAC solder bath at 235 $^{\circ}\!\!$ C ±2 $^{\circ}\!\!$ C	good tinning (>95% covered) no visible damage
Temperature cycling Clause 4.19	30 minutes at -55°C±3°C, 2~3 minutes at 25℃+2℃-1℃, 30 minutes at +155°C±3°C, 2~3 minutes at 25℃+2℃-1℃, total 5 continuous cycles	no visible damage J: Δ R/R max. \pm (1%+0.5m Ω) F: Δ R/R max. \pm (0.5%+0.5m Ω)
Load life (endurance) Clause 4.25	70±2°C, 1000 hours, loaded with RCWV or Vmax,1.5 hours on and 0.5 hours off	no visible damage J: $\Delta R/R$ max. $\pm (3\%+0.5m\Omega)$ F: $\Delta R/R$ max. $\pm (1\%+0.5m\Omega)$
Load life in Humidity Clause 4.24	1000 hours, at rated continuous working voltage in humidity chamber controller at 40°C±2°C and 90~95% relative humidity, 1.5hours on and 0.5 hours off	no visible damage J: Δ R/R max. \pm (3%+0.5m Ω) F: Δ R/R max. \pm (1%+0.5m Ω)
Insulation Resistance Clause 4.6	Resistance between termination and overcoat. test voltage 100+/-15V	Min. 1Gohm
Bending Clause 4.33	Resistance change after bended 3mm on the 90mm PCB. 2mm for 1206/ 2512!	no visible damage J: Δ R/R max. \pm (1%+0.5m Ω) F: Δ R/R max. \pm (0.5%+0.5m Ω)
Adhesion Clause 4.32	Pressurizing force: 1Kg, Test time: 60±1sec.	No remarkable damage or removal of the terminations

PACKAGING

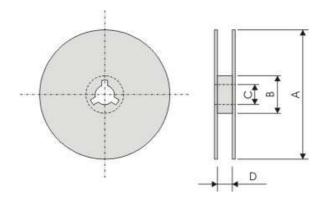
Paper Tape specifications (unit :mm)



Series No.	А	В	W	F	Е
WW08K	2.40±0.20	1.65±0.20	8.00±0.30	3.50±0.05	1.75±0.10
WW12K	3.60±0.20	2.00±0.20	8.00±0.30	3.50±0.05	1.75±0.10
WW25K	6.75±0.20	3.50±0.20	12.00±0.30	3.50±0.05	1.75±0.10

Series No.	P1	P0	ΦD
WW08K	4.00±0.10	4.00±0.10	$\Phi 1.50^{+0.1}_{-0.0}$
WW12K	WW12K 4.00±0.10		Φ 1.50 $^{+0.1}_{-0.0}$
WW25K	4.00±0.10	4.00±0.10	Ф1.50 ^{+0.1} _{-0.0}

Reel dimensions



Size	Α	В	С	D
0805/1206	Φ178.0±2.0	Φ60.0±1.0	13.0±0.5	10.0±1.5
2512	Φ178.0±2.0	Φ60.0±1.0	13.0±0.5	13.8±1.5

Taping qty: 0805: 5,000pcs per reel; 1206: 4,000pcs per reel; 2512: 4,000pcs per reel